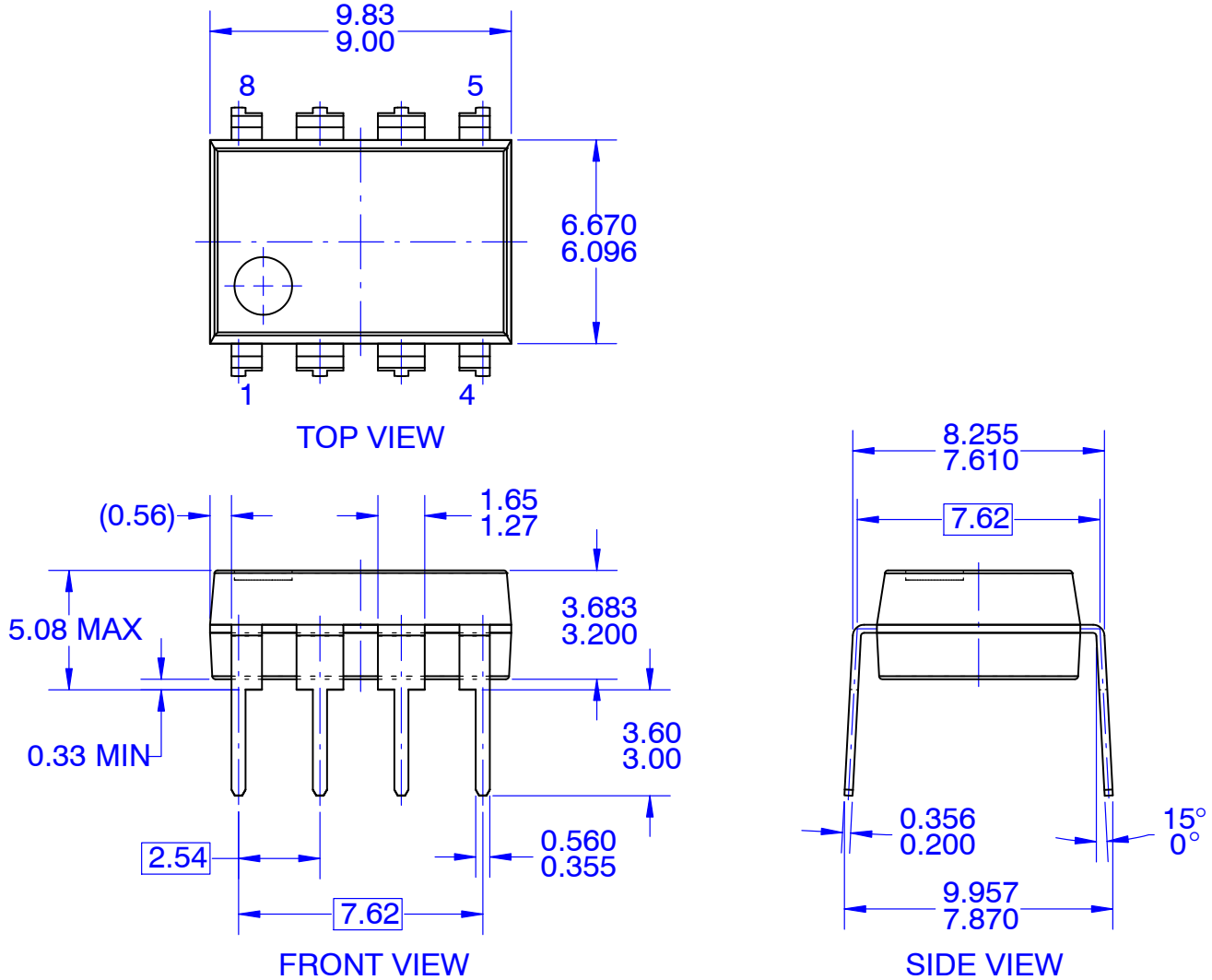


**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

PDIP8 9.42x6.38, 2.54P  
CASE 646CM  
ISSUE O

DATE 31 JUL 2016



**NOTES:**

- A. CONFORMS TO JEDEC MS-001, VARIATION BA
- B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- D. DIMENSIONS AND TOLERANCES PER ASME Y14.5M-2009

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